

01-18-2001

ATTORNEY DOCKET NO. G0028

1.3.01



101586842

Original documents or copy thereof.

To the Honorable Commissioner of Patents :

1. Name of conveying party(ies):

(a) Steven Webster

2. Name and address of receiving party(ies):

Name: Amkor Technology, Inc.

Internal Address: \_\_\_\_\_

Street Address: 1900 South Price Road

City: Chandler State: AZ Zip: 85248-

Additional name(s) & address(es) ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other \_\_\_\_\_

Execution Date: December 26, 2000

4. Application number(s) or patent number(s)

If this document is being filed with a new application, the execution date of the application is: December 26, 2000

A. Patent Application No.(s)

Entitled "Bond Wire Pressure Sensor Die Package"

B. Patent No.(s)

09754393

01/09/2001 WKORDMA 00000019 09754393

64 FC:581

40.00 Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Philip J. McKay

Internal Address: Gunnison, McKay &amp; Hodgson, L.L.P.

Street Address: Garden West Office Plaza, Suite 220

1900 Garden Road

City: Monterey State: CA Zip: 93940

6. Total Number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)-----\$ 40.00

- ☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Philip J. McKay

Name of Person Signing

Signature

1/3/01

Date

Total number of pages including cover sheet, attachments, and documents 2

# ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, Steven Webster of 2380 West Myrtle Dr., Chandler, AZ. 85248, hereby sell, assign and transfer to Amkor Technology, Inc., a Pennsylvania corporation, having a place of business at 1900 South Price Road, Chandler, AZ 85248-1604 its successors and assigns, the entire right, title and interest throughout the world in my invention in

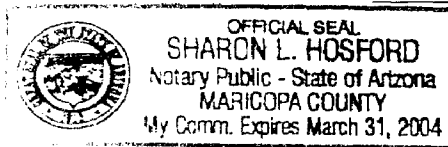
Bond Wire Pressure Sensor Die Package

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 26<sup>th</sup> day of December, 2000.

*Steven Webster*

Steven Webster  
(Full Name)



State of Arizona )  
 ) ss.  
County of Maricopa)

On 12/26/00 before me, Sharon L. Hosford personally  
appeared Steven Webster personally known to me or proved to  
me on the basis of satisfactory evidence to be the person(s) whose name(s) is(are) subscribed to  
the within instrument and acknowledged to me that he/she/they executed the same in  
his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the  
person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

WITNESS my hand and official seal.

*Sharon L. Hosford*  
SIGNATURE OF NOTARY